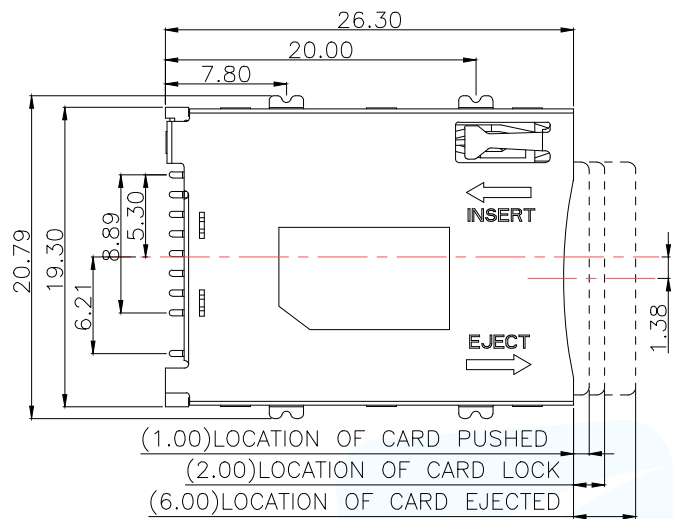
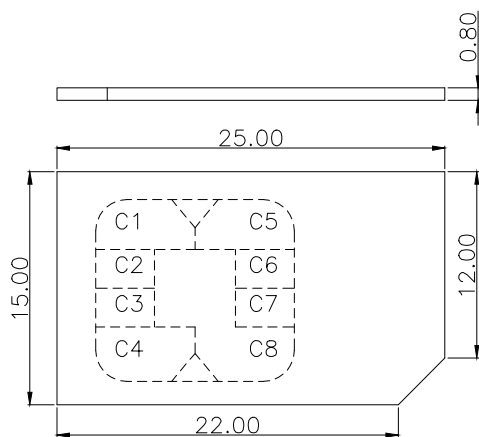
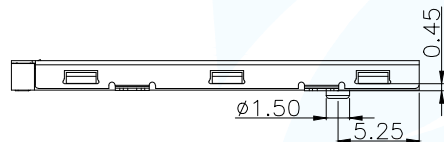
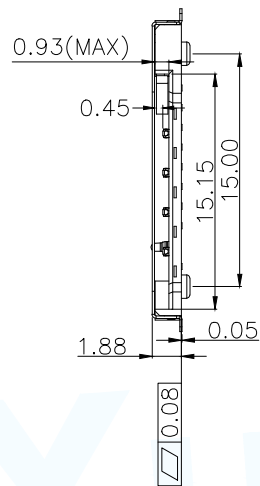




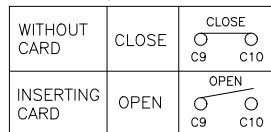
(1.00)LOCATION OF CARD PUSHED
(2.00)LOCATION OF CARD LOCK
(6.00)LOCATION OF CARD EJECTED



▨ PAD AREA
■ KEEP OUT AREA

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ± 0.05

Circuit Diagram for Detect Switch



NOTES:

1.MATERIAL:

HOUSING: HIGH TEMPERATURE THERMOPLASTIC
UL94V_0,COLOR:BLACK.

CONTACT: COPPER ALLOYS.

COVER: COPPER ALLOYS OR STEEL.

2.PLATING:

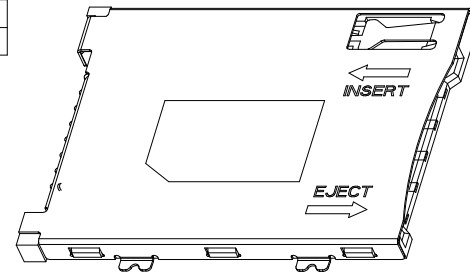
UNDERPLATE: NICKEL.

CONTACT AREA: GOLD OVER NICKEL.

SOLDER AREA: TIN OVER NICKEL.

3.MULTIMEDIA CARD COMPATIBLE

MINI SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	GND OF SIM
C3	RST OF SIM
C4	VPP OF SIM
C5	CLK OF SIM
C6	I/O OF SIM
C7	DATO OF SIM
C8	MCMD OF SIM
C9	CARD DETECT SWITCH
C10	GND OF SIM



MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES		TITLE:MINI SIM CARD PUSH PUSH 8+1P SMT有柱 H1.9	
DECIMALS:		PAR	SIM-115C
ANGLES:		DWN	helen
X.X:±0.35		CHKD	
X.XX:±0.25		APVD	
X.XXX:±0.15		SCALE:1:1	UNIT:MM
CUSTOMER COPY		SIZE:A4	SHEET:1F1
			REV:A